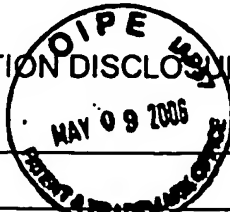


<div style="display: flex; justify-content: space-between; align-items: center;"> <div style="text-align: center;">  <p>INFORMATION DISCLOSURE CITATION</p> </div> <div style="text-align: right;"> <p>ATTY DOCKET NO. P-US075-A-MG</p> <p>APPLICATION NO. 10/607,931</p> <p>APPLICANT(S) Brown, et al.</p> <p>FILING DATE June 27, 2003</p> <p>GROUP ART UNIT 2817</p> </div> </div>					U.S. PATENT DOCUMENTS		
*EXAMINER INITIAL	DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE	
<div style="display: flex; align-items: center;"> <div style="writing-mode: vertical-rl; transform: rotate(180deg); font-weight: bold; margin-right: 5px;">↓</div> <div style="text-align: center;"> <p>KG</p> <p>1</p> <p>2</p> <p>3</p> <p>4</p> <p>5</p> <p>6</p> <p>7</p> </div> </div>	1	4,021,789	05/03/1977	Furman, et al.	365	182	
	2	4,127,831	11/28/1978	Gordon P. Riblet	333	10	
	3	4,958,222	09/18/1990	Kabushiki Kaisha Toshiba	357	84	
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	6	6,027,630	02/22/2000	Adam L. Cohen	205	135	
	7	6,572,742	06/03/2003	Adam L. Cohen	204	297.5	
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*EXAMINER INITIAL	DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE	
<div style="display: flex; align-items: center;"> <div style="writing-mode: vertical-rl; transform: rotate(180deg); font-weight: bold; margin-right: 5px;">↓</div> <div style="text-align: center;"> <p>KG</p> <p>8</p> <p>9</p> <p>10</p> <p>11</p> <p>12</p> <p>13</p> <p>14</p> <p>15</p> <p>16</p> <p>17</p> <p>18</p> </div> </div>	8	2003/0127336	07/10/2003	Cohen, et al.	205	118	
	9	2003/0221968	12/04/2003	Cohen, et al.	205	118	
	10	2003/0222738	12/04/2003	Brown, et al.	333	160	
	11	2003/0234179	12/25/2003	Christopher A. Bang	205	118	
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	18	2004/0065555	04/08/2004	Gang Zhang	205	118	
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<p>*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.</p>							

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				FILING DATE June 27, 2003		GROUP ART UNIT 2817	
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↓	20	JP 8-274167	10/18/1996				No - Abstract only
	21	JP 1-125956	05/18/1989				No - Abstract only
	22	JP 6-232217	08/19/1994				No - Abstract only
	23	RU 2046469	10/20/1995		H01P	5/18	No - Abstract only
	24	WO 2000/39854	07/06/2000	Kwon, et al.	H01L	27/00	N/A
	25	WO 2003/049514	06/12/2003	Brown, et al.	H05K	3/00	N/A
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↓	27	Adam L. Cohen, et al., "EFAB: Rapid, Low-Cost Desktop Micromachining of High Aspect Ratio True 3-D MEMS", Proc. 12th IEEE Micro Electro Mechanical Systems Workshop, IEEE, Jan 1999, pg. 244.					
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	29	Adam L. Cohen, "3-D Micromachining by Electrochemical Fabrication", Micromachine Devices, March 1999, pgs. 6-7.					
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